10V Drive Nch MOSFET

RCX160N20

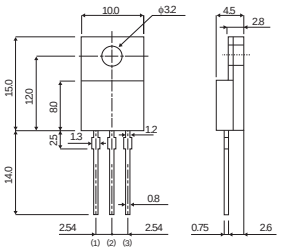
● Structure
Silicon N-channel MOSFET

● Features
1) Low on-resistance.
2) Low input capacitance.
3) High ESD.

● Application
Switching

● Dimensions (Unit : mm)

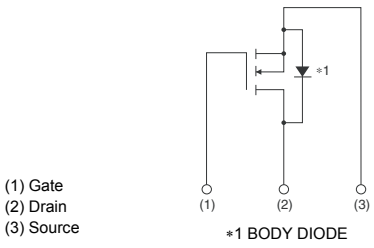
TO-220FM



● Packaging specifications

Type	Package	Bulk
	Code	-
	Basic ordering unit (pieces)	500
RCX160N20		○

● Inner circuit



● Absolute maximum ratings (Ta = 25°C)

Parameter		Symbol	Limits	Unit
Drain-source voltage		V_{DSS}	200	V
Gate-source voltage		V_{GSS}	±30	V
Drain current	Continuous	I_D *3	±16	A
	Pulsed	I_{DP} *1	±64	A
Source current (Body Diode)	Continuous	I_S	16	A
	Pulsed	I_{SP} *1	64	A
Avalanche current		I_{AS} *2	8	A
Avalanche energy		E_{AS} *2	20.7	mJ
Power dissipation		P_D *4	40	W
Channel temperature		Tch	150	°C
Range of storage temperature		Tstg	−55 to +150	°C

*1 Pw≤10μs, Duty cycle≤1%

*2 L≒ 500μH, V_{DD}=50V, R_G=25Ω, T_{ch}=25°C

*3 Limited only by maximum channel temperature allowed.

*4 T_C=25°C

● Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to Case	Rth (ch-c)*	3.125	°C / W

* T_C=25°C

* Limited only by maximum channel temperature allowed.

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● **Electrical characteristics** (Ta = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I_{GSS}	-	-	±100	nA	V_{GS}=±30V, V_{DS}=0V
Drain-source breakdown voltage	$V_{(BR)DSS}$	200	-	-	V	I_D=1mA, V_{GS}=0V
Zero gate voltage drain current	I_{DSS}	-	-	10	μA	V_{DS}=200V, V_{GS}=0V
Gate threshold voltage	$V_{GS\ (th)}$	3.25	-	5.25	V	V_{DS}=10V, I_D=1mA
Static drain-source on-state resistance	$R_{DS\ (on)}$ *	-	135	180	mΩ	I_D=8A, V_{GS}=10V
Forward transfer admittance	$\|Y_{fs}\|$ *	4	8	-	S	V_{DS}=10V, I_D=8A
Input capacitance	C_{iss}	-	1370	-	pF	V_{DS}=25V
Output capacitance	C_{oss}	-	95	-	pF	V_{GS}=0V
Reverse transfer capacitance	C_{rss}	-	50	-	pF	f=1MHz
Turn-on delay time	$t_{d(on)}$ *	-	27	-	ns	V_{DD}≒100V, I_D=8A
Rise time	t_r *	-	47	-	ns	V_{GS}=10V
Turn-off delay time	$t_{d(off)}$ *	-	42	-	ns	R_L=12.5Ω
Fall time	t_f *	-	17	-	ns	R_G=10Ω
Total gate charge	Q_g *	-	26	-	nC	V_{DD}≒100V, I_D=16A
Gate-source charge	Q_{gs} *	-	10	-	nC	V_{GS}=10V
Gate-drain charge	Q_{gd} *	-	11	-	nC	

*Pulsed

● **Body diode characteristics** (Source-Drain)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward Voltage	V_{SD} *	-	-	1.5	V	I_s=16A, V_{GS}=0V

*Pulsed

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●Electrical characteristic curves (Ta=25°C)

Fig.1 Typical Output Characteristics (Ⅰ)

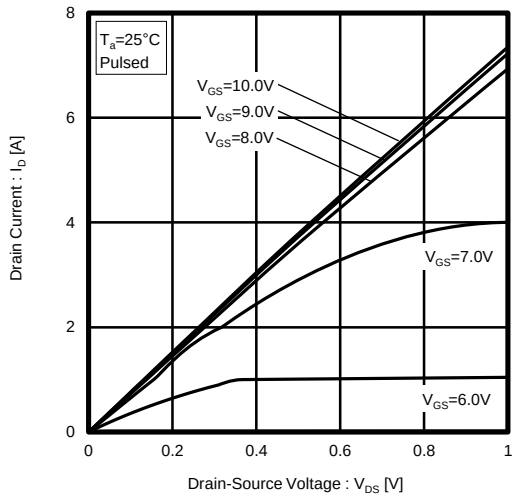

Fig.2 Typical Output Characteristics (Ⅱ)

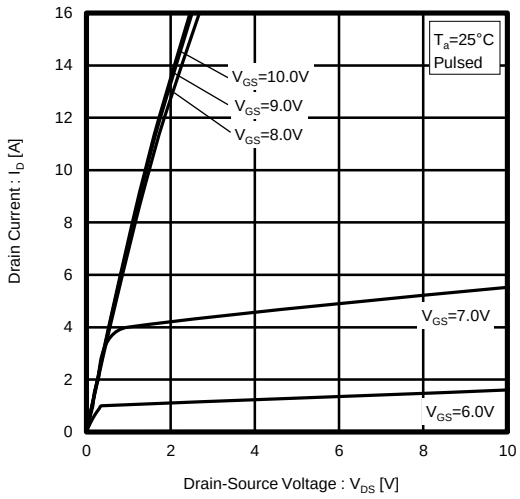

Fig.3 Typical Transfer Characteristics

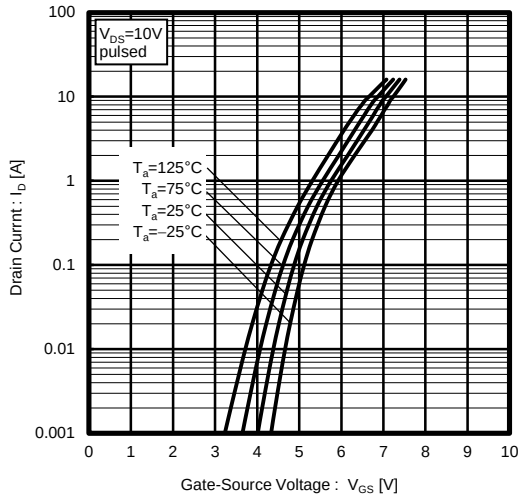

Fig.4 Gate Threshold Voltage vs. Channel Temperature

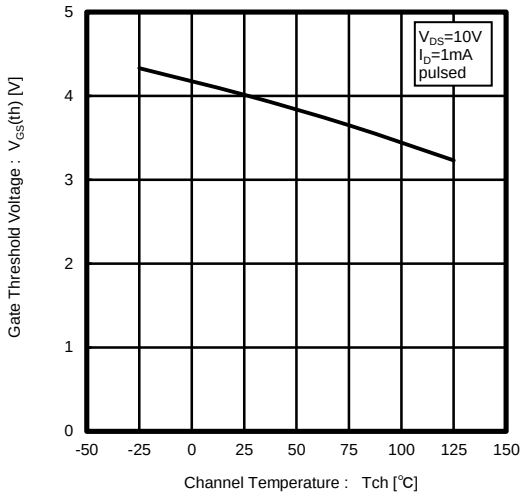

Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

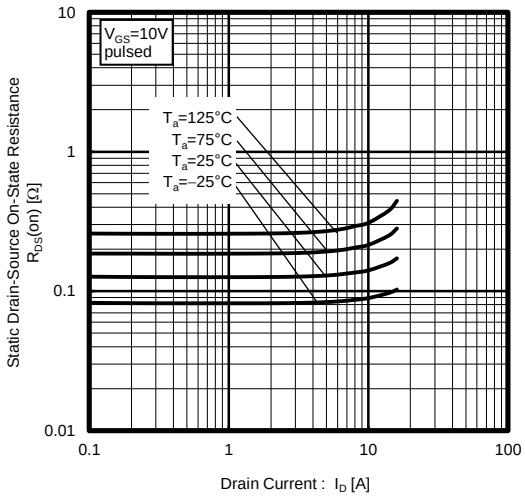

Fig.6 Static Drain-Source On-State Resistance vs. Channel Temperature

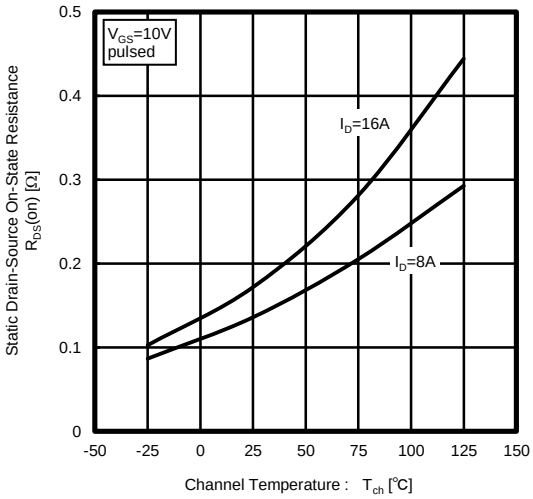

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Fig.7 Forward Transfer Admittance vs. Drain Current

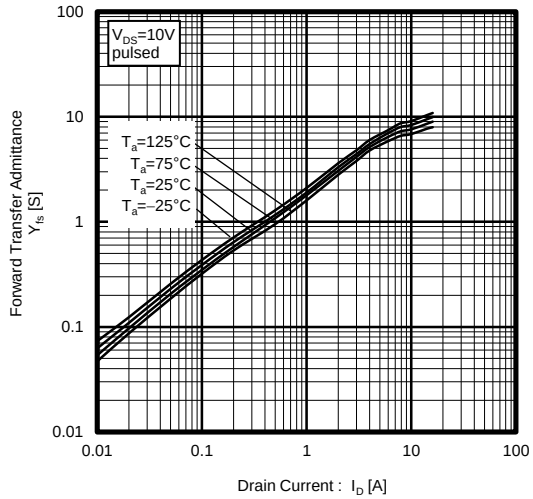

Fig.8 Source Current vs. Source-Drain Voltage

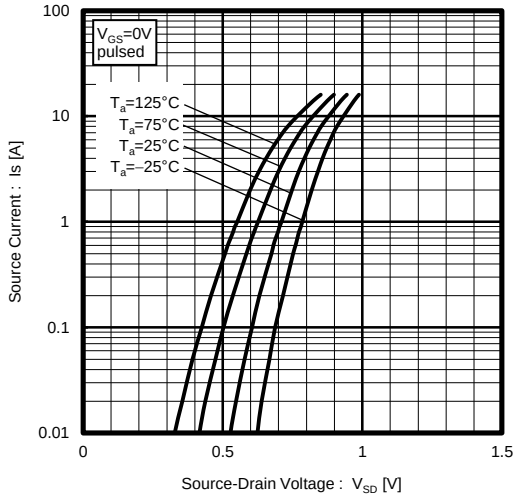

Fig.9 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

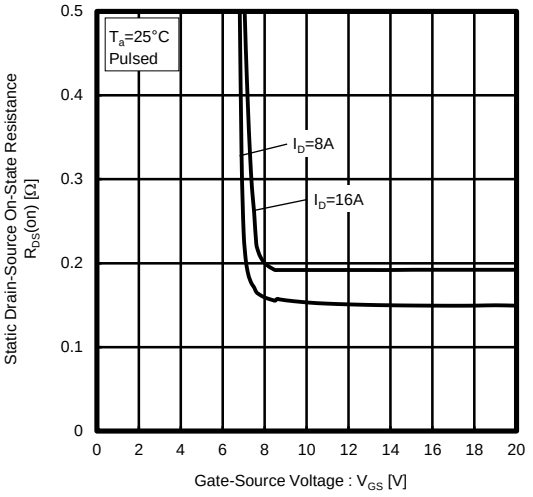

Fig.10 Switching Characteristics

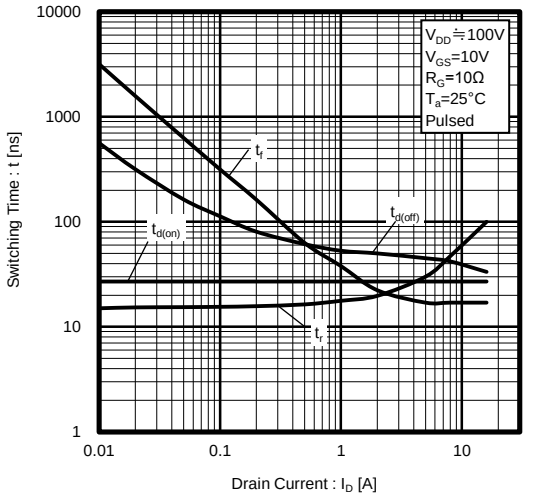

Fig.11 Dynamic Input Characteristics

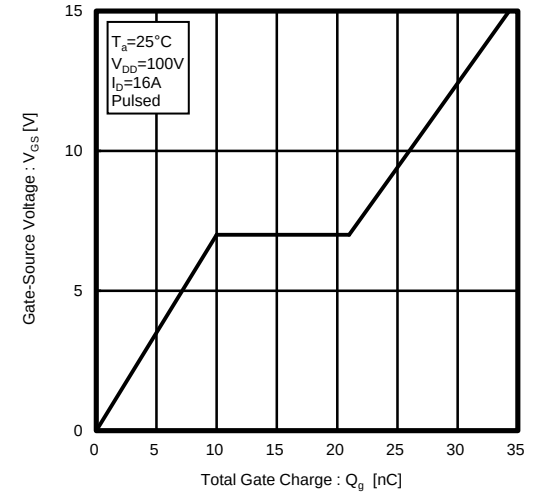

Fig.12 Typical Capacitance vs. Drain-Source Voltage

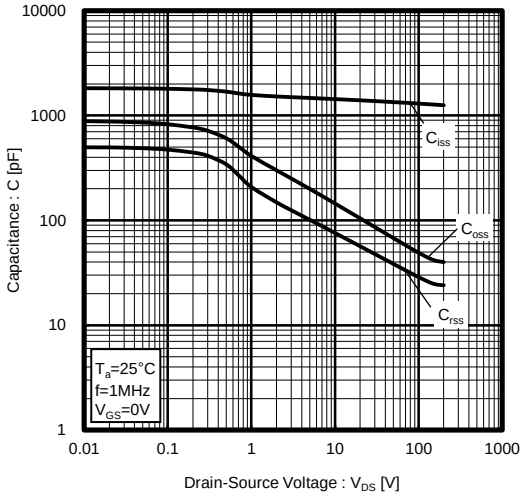

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Fig.13 Maximum Safe Operating Area

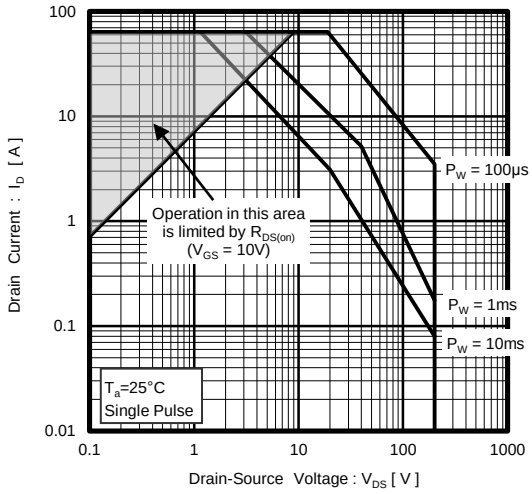
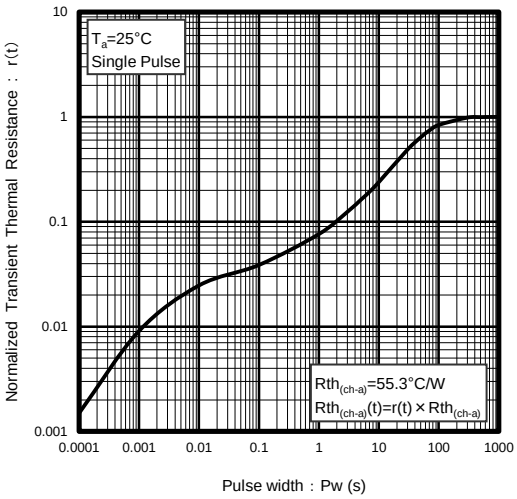


Fig.14 Normalized Transient Thermal Resistance v.s. Pulse Width



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● Measurement circuits

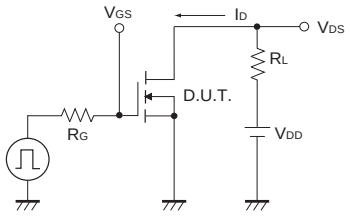

Fig.1-1 Switching Time Measurement Circuit

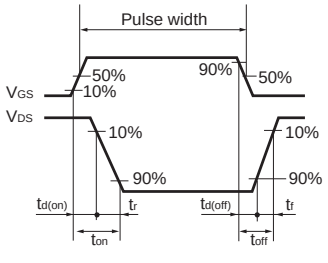

Fig.1-2 Switching Waveforms

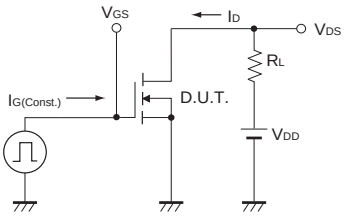

Fig.2-1 Gate Charge Measurement Circuit

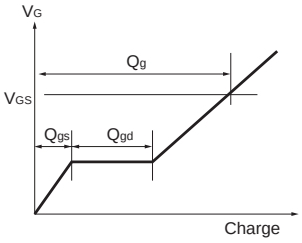

Fig.2-2 Gate Charge Waveform

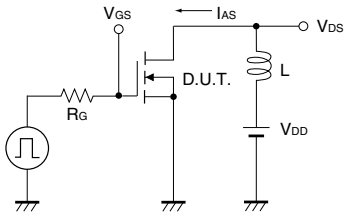

Fig.3-1 Avalanche Measurement Circuit

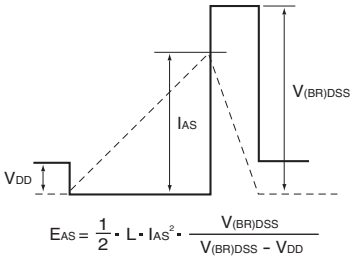

Fig.3-2 Avalanche Waveform

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